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Please note: As part of the Fairchild Semiconductor integration, some of the Fairchild orderable part numbers will need to change in order to meet ON Semiconductor's system requirements. Since the ON Semiconductor product management systems do not have the ability to manage part nomenclature that utilizes an underscore (_), the underscore (_) in the Fairchild part numbers will be changed to a dash (-). This document may contain device numbers with an underscore (_). Please check the ON Semiconductor website to verify the updated device numbers. The most current and up-to-date ordering information can be found at www.onsemi.com. Please email any questions regarding the system integration to Fairchild <a href="general-regarding-numbers-n

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November 2015

FGH75T65SHDTL4 650 V, 75 A Field Stop Trench IGBT

Features

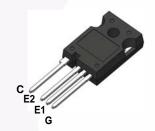
- Maximum Junction Temperature: T_{.I} =175°C
- · Positive Temperature Co-efficient for Easy Parallel Operating
- · High Current Capability
- Low Saturation Voltage: $V_{CE(sat)} = 1.6 \text{ V(Typ.)} @ I_C = 75 \text{ A}$
- 100% of the Parts Tested for I_{LM}(1)
- · High Input Impedance
- Fast Switching
- · Tighten Parameter Distribution
- · Pb Free and RoHS Compliant
- · Do Not Recommend for Reflow and Full PKG Dipping

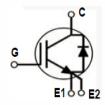
General Description

Using novel field stop IGBT technology, Fairchild's new series of field stop 3rd generation IGBTs offer the optimum performance for solar inverter, UPS, welder, telecom, ESS and PFC applications where low conduction and switching losses are essential.

Applications

· Solar Inverter, UPS, Welder, Telecom, ESS, PFC





E1: Kelvin Emitter E2: Power Emitter

Absolute Maximum Ratings T_C = 25°C unless otherwise noted

Symbol	Description		FGH75T65SHDTL4	Unit
V _{CES}	Collector to Emitter Voltage		650	V
M	Gate to Emitter Voltage		± 20	V
V_{GES}	Transient Gate to Emitter Voltage		± 30	V
I.	Collector Current	@ T _C = 25°C	150	А
IC	Collector Current	@ T _C = 100°C	75	А
I _{LM (1)}	Pulsed Collector Current @ T _C = 25°C		300	А
I _{CM (2)}	Pulsed Collector Current		300	Α
	Diode Forward Current	@ T _C = 25°C	125	Α
I _F	Diode Forward Current	@ T _C = 100°C	75	Α
I _{FM (2)}	Pulsed Diode Maximum Forward Curre	300	Α	
P _D	Maximum Power Dissipation	@ T _C = 25°C	455	W
	Maximum Power Dissipation	$@ T_C = 100^{\circ}C$	227	W
T _J	Operating Junction Temperature		-55 to +175	°C
T _{stg}	Storage Temperature Range		-55 to +175	°C
T _L	Maximum Lead Temp. for soldering Purposes, 1/8" from case for 5 seconds	3	300	°C

Notes:

- 1. V_{CC} = 400 V, V_{GE} = 15 V, I_{C} = 300 A, R_{G} = 73 Ω , Inductive Load
- 2. Repetitive rating: Pulse width limited by max. junction temperature

Thermal Characteristics

Symbol	Parameter	FGH75T65SHDTL4	Unit	
$R_{\theta JC}(IGBT)$	Thermal Resistance, Junction to Case, Max.	0.33	°C/W	
$R_{\theta JC}(Diode)$	Thermal Resistance, Junction to Case, Max.	0.65	°C/W	
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient, Max.	40	°C/W	

Package Marking and Ordering Information

Part Number	Top Mark	Package	Packing Method	Reel Size	Tape Width	Quantity
FGH75T65SHDTL4	FGH75T65SHDTL4	TO-247 A04	Tube	-	-	30

Electrical Characteristics of the IGBT T_C = 25°C unless otherwise noted

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
Off Charac	teristics					
BV _{CES}	Collector to Emitter Breakdown Voltage	$V_{GE} = 0V$, $I_C = 1$ mA	650	-	-	V
ΔBV _{CES} / ΔΤ _J	Temperature Coefficient of Breakdown Voltage	I _C = 1 mA, Reference to 25°C	-	0.65	-	V/°C
I _{CES}	Collector Cut-Off Current	$V_{CE} = V_{CES}$, $V_{GE} = 0$ V	-	-	250	μА
I _{GES}	G-E Leakage Current	$V_{GE} = V_{GES}, V_{CE} = 0 V$	-	-	±400	nA
On Charac	teristics					
V _{GE(th)}	G-E Threshold Voltage	$I_C = 75 \text{ mA}, V_{CE} = V_{GE}$	4.0	5.5	7.5	V
- (* /		I _C = 75 A, V _{GE} = 15 V	-	1.6	2.1	V
V _{CE(sat)}	Collector to Emitter Saturation Voltage	I _C = 75 A, V _{GE} = 15 V, T _C = 175°C	-	2.28	-	V
Dynamic C	haracteristics					
C _{ies}	Input Capacitance		-	3710	-	pF
C _{oes}	Output Capacitance	$V_{CE} = 30 \text{ V}, V_{GE} = 0 \text{ V},$ f = 1MHz	-	183	-	pF
C _{res}	Reverse Transfer Capacitance	11 - 11011112	-	43	-	pF
Switching	Characteristics					
t _{d(on)}	Turn-On Delay Time		-	55	-	ns
t _r	Rise Time		-	50	-	ns
t _{d(off)}	Turn-Off Delay Time	$V_{CC} = 400 \text{ V}, I_{C} = 75 \text{ A},$	-	189	-/	ns
t _f	Fall Time	$R_G = 15 \Omega$, $V_{GE} = 15 V$,	-	39	-	ns
E _{on}	Turn-On Switching Loss	Inductive Load, T _C = 25°C	-	1.06	- /	mJ
E _{off}	Turn-Off Switching Loss		-	1.56	- //	mJ
E _{ts}	Total Switching Loss		-	2.62	- \	mJ
t _{d(on)}	Turn-On Delay Time		-	48	-	ns
t _r	Rise Time		-	56	-	ns
t _{d(off)}	Turn-Off Delay Time	$V_{CC} = 400 \text{ V}, I_{C} = 75 \text{ A},$ $R_{G} = 15 \Omega, V_{GE} = 15 \text{ V},$	-	205	-	ns
t _f	Fall Time		-	40	-	ns
E _{on}	Turn-On Switching Loss	Inductive Load, T _C = 175°C	-	2.34	-	mJ
E _{off}	Turn-Off Switching Loss		-	1.81	-	mJ
E _{ts}	Total Switching Loss		-	4.15	-	mJ

Electrical Characteristics of the IGBT (Continued)

Symbol	Parameter	Test Conditions	Min.	Тур.	Max	Unit
Qg	Total Gate Charge	V _{CE} = 400 V, I _C = 75 A, V _{GE} = 15 V	-	126	-	nC
Q _{ge}	Gate to Emitter Charge		-	24.1	-	nC
Q _{gc}	Gate to Collector Charge		-	47.6	-	nC

Electrical Characteristics of the Diode T_C = 25°C unless otherwise noted

Symbol	Parameter	Test Conditions		Min.	Тур.	Max	Unit
V _{FM}	Diode Forward Voltage	I _F = 75 A	$T_{\rm C} = 25^{\rm o}{\rm C}$	-	1.8	2.1	V
			$T_{\rm C} = 175^{\rm o}{\rm C}$	-	1.7	-	
E _{rec}	Reverse Recovery Energy		$T_{\rm C} = 175^{\rm o}{\rm C}$	-	160	-	uJ
t	Diode Reverse Recovery Time	$I_F = 75 \text{ A}, dI_F/dt = 200 \text{ A/}\mu\text{s}$	$T_{\rm C} = 25^{\rm o}{\rm C}$	-	76	-	ns
t _{rr} Diode Reverse Recovery Time	Blodd Novolod Nocovery Time		$T_{\rm C} = 175^{\rm o}{\rm C}$	=	270	-	1.0
Q _{rr}	Diode Reverse Recovery Charge		$T_{\rm C} = 25^{\rm o}{\rm C}$	\	206	-	nC
⊄ II	Blode Nevered Necestery Charge		$T_{\rm C} = 175^{\rm o}{\rm C}$	-	2199	-	110

Figure 1. Typical Output Characteristics

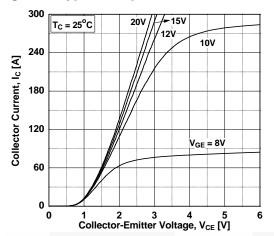


Figure 3. Typical Saturation Voltage Characteristics

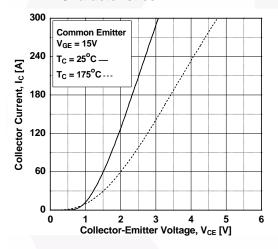


Figure 5. Saturation Voltage vs. V_{GE}

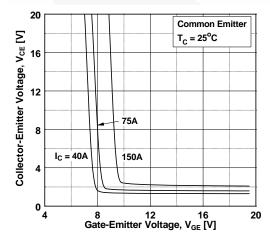


Figure 2. Typical Output Characteristics

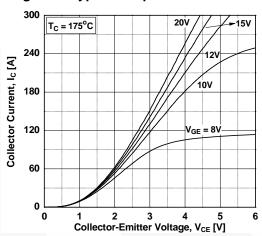


Figure 4. Saturation Voltage vs. Case
Temperature at Variant Current Level

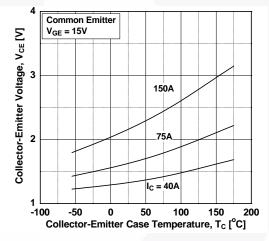


Figure 6. Saturation Voltage vs. V_{GE}

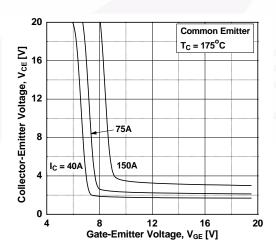


Figure 7. Capacitance Characteristics

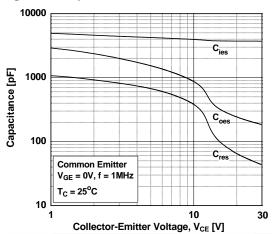


Figure 8. Gate charge Characteristics

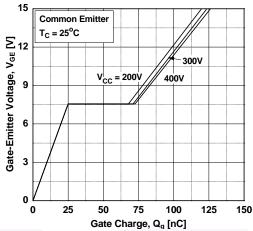


Figure 9. Turn-on Characteristics vs.
Gate Resistance

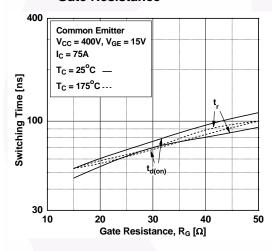


Figure 10. Turn-off Characteristics vs.
Gate Resistance

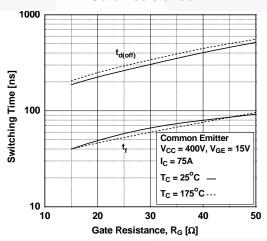


Figure 11. Switching Loss vs.
Gate Resistance

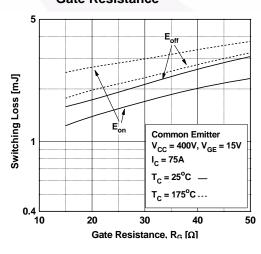


Figure 12. Turn-on Characteristics vs. Collector Current

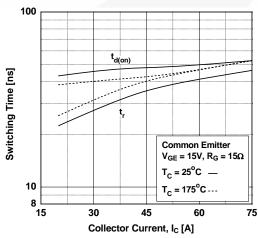
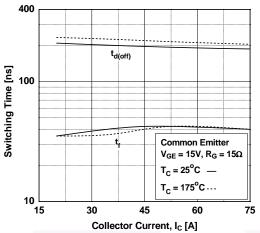


Figure 13. Turn-off Characteristics vs. **Collector Current**



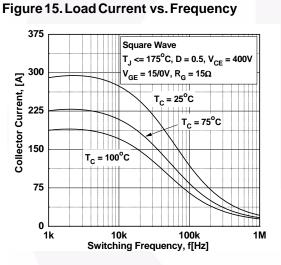


Figure 17. Forward Characteristics

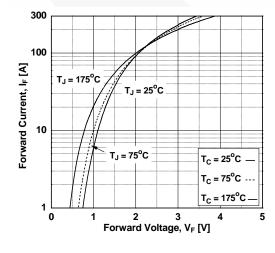


Figure 14. Switching Loss vs. Collector Current

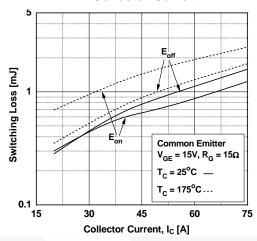


Figure 16. SOA Characteristics

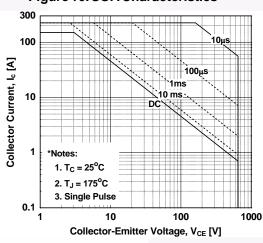


Figure 18. Reverse Recovery Current

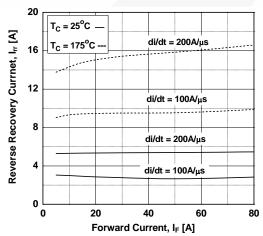


Figure 19. Reverse Recovery Time

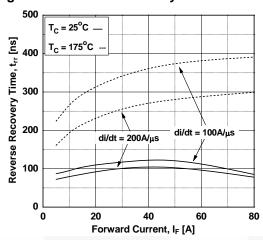


Figure 20. Stored Charge

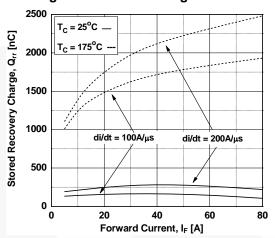


Figure 21.Transient Thermal Impedance of IGBT

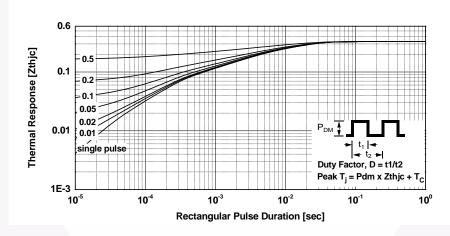
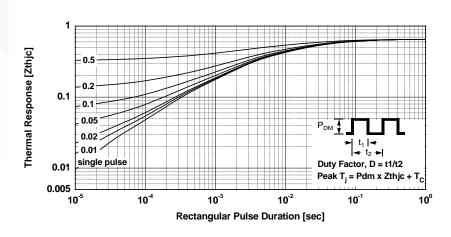
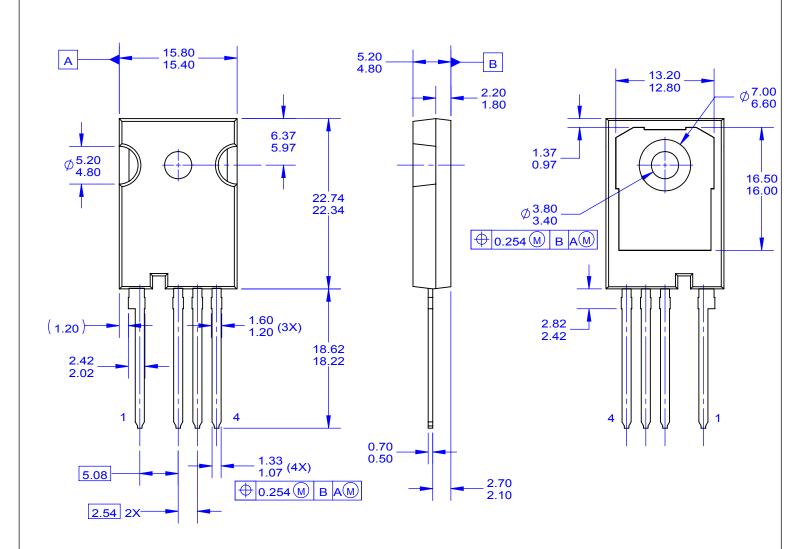


Figure 22. Transient Thermal Impedance of Diode





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